# Chip Box - Assembled



## RoHS Compliant



#### **Description**

The product is a Chip Box with conductive foam. This chip box provide an ESD safe and small electronic devices. Designed from conductive corrugated fiberboard. Assembled with high density pin stick grade conductive foam.

### **Specifications**

ESD Storage Type : Box

External Dimension L x W x D (mm): :  $120 \times 100 \times 15$ External Dimension L x W x D (in): :  $4.7 \times 3.9 \times 0.5$ 

#### **Part Number Table**

Description	Part Number
Chip Box with conductive foam	026-0466

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